

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below.

Dated: April 4, 2002,

Signature: 

(Marcus J. Millet)



Docket No.: TESSERA 3.3-018 CONT CONT II  
DIV CONT CONT  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Khandros et al.

Application No.: 09/656,690

Group Art Unit: 2812

Filed: September 7, 2000

Examiner: D. Graybill

For: FACE-UP SEMICONDUCTOR CHIP  
ASSEMBLIES

Commissioner for Patents  
Washington, DC 20231

**INFORMATION DISCLOSURE STATEMENT**

Dear Sir:

It is respectfully requested that the references listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each reference is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

In the event that any fee is due in connection with the present Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: April 4, 2002

Respectfully submitted,

By 

Marcus J. Millet

Registration No.: 28,241

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JDS

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Washington, DC 20231

REQUEST FOR CONSIDERATION OF INFORMATION UNDER 37 CFR § 1.97 (C)

Dear Sir:

It is respectfully requested that the references cited in the enclosed form be considered pursuant to 37 C.F.R. § 1.97(c). Please charge deposit account No. 12-1095 in the amount of \$180.00 pursuant to 37 C.F.R. § 1.17(p). In the event that any additional fee is due in connection with the present request, the same should be charged to our deposit account No. 12-1095.

Dated: April 4, 2002

Respectfully submitted,

By 

Marcus J. Millet

Registration No.: 28,241

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